2.0 x 1.6 mm size MHz range crystal unit: FA-128

Features

- Package size: 2.0 x 1.6 mm, t = 0.5 mm Max.
- Frequency range: 19.2 MHz to 54 MHz
- Frequency tolerance (standard): ±10 x 10^{-6} / ±30 x 10^{-6} (@+25 °C)
- Frequency vs. temperature characteristics (standard):
  ±12 x 10^{-6} (-20 °C to +75 °C)
  ±17 x 10^{-6} (-30 °C to +85 °C)
  ±20 x 10^{-6} (-40 °C to +85 °C)
  ±30 x 10^{-6} (-40 °C to +105 °C)
- ESR: 150 Ω Max. (19.2 MHz ≤ f_nom < 20 MHz)
  100 Ω Max. (20 MHz ≤ f_nom < 26 MHz)
  60 Ω Max. (26 MHz ≤ f_nom ≤ 54 MHz)



FA-128
(2.0 x 1.6 mm, t = 0.5 mm Max.)

Applications

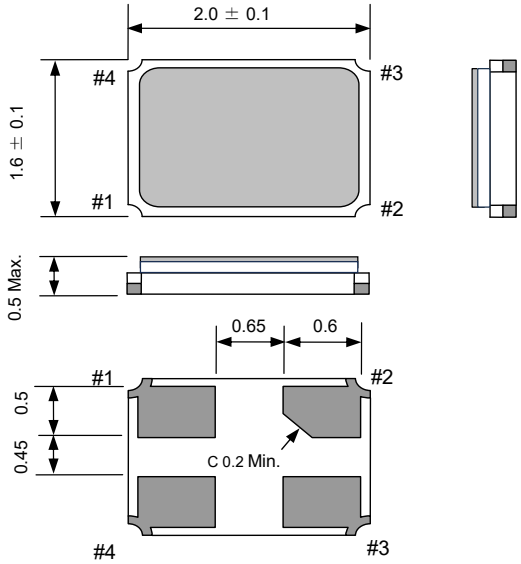
- Small communication module for consumer and industrial applications
- Wearable devices
- Clock for MCU

Description

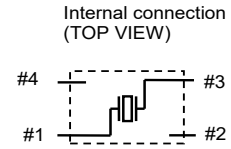
The FA-128 has been commercialized as a reference clock for communication modules, which requires high accuracy, and as a clock for wireless communication and microcomputers for applications that require miniaturization (TWS (True Wireless Stereo), Smart Watch, etc.).

The products created using the element processing technology cultivated over many years contribute to improving the performance of the customer's system.

Outline Drawing and Terminal Assignment



Pin	Connection
#1	X'tal
#2	GND
#3	X'tal
#4	GND



#2 and #4 are connected to the cover.
(Please connect to ground)

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[1] Product Number / Product Name

(1-1) Product Number

Q22FA1280xxxx18 (Please contact Epson for details)

(1-2) Product Name (Standard Form)

FA-128 24.000000MHz 12.0 +10.0-10.0

① ② ③ ④

①Model ②Frequency ③Load capacitance (pF) ④Frequency tolerance ($x10^{-6}$, +25 °C)

In addition to the mentioned above specification items (① to ④),
pleases specify the frequency vs. temperature characteristics.

[2] Absolute Maximum Ratings

Item	Symbol	Rating value			Unit	Note
		Min.	Typ.	Max.		
Storage temperature range	T_stg	-40	-	+125	°C	Satisfy environmental characteristics specifications
Level of drive	DL	-	-	200	µW	

[3] Operating Conditions

Item	Symbol	Rating value			Unit	Note
		Min.	Typ.	Max.		
Operating temperature range	T_use	-40	-	+105	°C	
		-40	-	+125		Please contact Epson
Level of drive	DL	1		200	µW	Recommended: 10 µW

[4] Static Characteristics

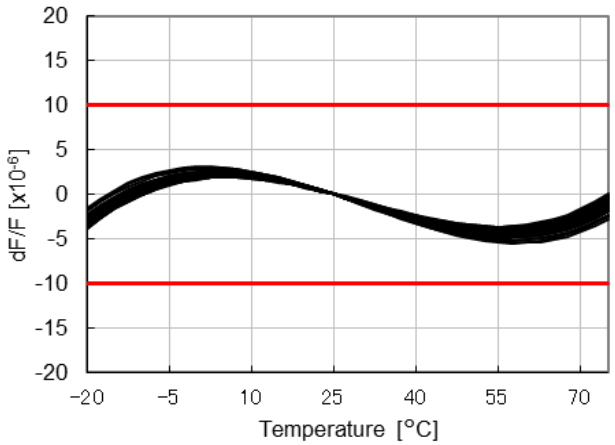
Item	Symbol	Specifications	Unit	Condition / Remarks
Nominal frequency range	f_nom	19.2000 to 54.000	MHz	Please contact us about available frequencies.
Frequency tolerance (Standard)	f_tol	±10	$x10^{-6}$	T_use = +25 °C ± 3 °C DL = 100 µW Does not include frequency aging Please contact Epson for requirements not listed in the specifications
Frequency vs. temperature characteristics (Standard)	f_tem	±12 (-20 °C ~ +75 °C)	$x10^{-6}$	Reference at T_use = +25 °C ± 3 °C Please contact Epson for requirements not listed in the specifications
		±17 (-30 °C ~ +85 °C)		
		±20 (-40 °C ~ +85 °C)		
		±30 (-40 °C ~ +105 °C)		
Load capacitance	CL	6 to ∞	pF	Please specify
Motional resistance (ESR)	R1	Table 1.	Ω	π circuit IEC 60444-2 T_use = Operating temperature range DL = 100 µW
Shunt capacitance	C0	3.0 Max.	pF	
Frequency aging	f_age	±1 (19.2 MHz ≤ f_nom ≤ 40 MHz)	$x10^{-6}$	T_use = +25 °C ± 3 °C First year
		±2 (40 MHz < f_nom ≤ 54 MHz)		

Table 1.

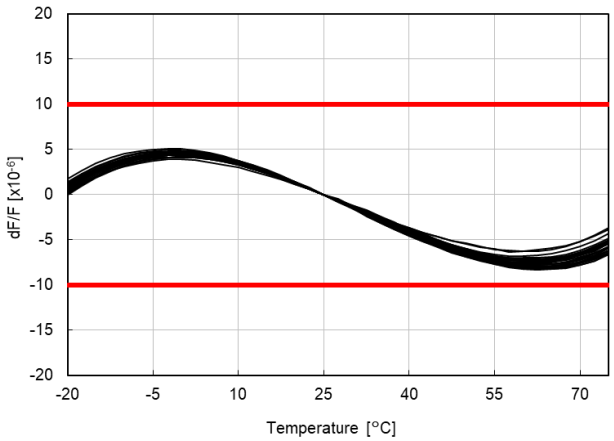
Frequency	R1
19.2 MHz ≤ f_nom < 20 MHz	150 Ω Max.
20 MHz ≤ f_nom < 26 MHz	80 Ω Max.
26 MHz ≤ f_nom ≤ 54 MHz	60 Ω Max.

[5] Example of Frequency Temperature Characteristics

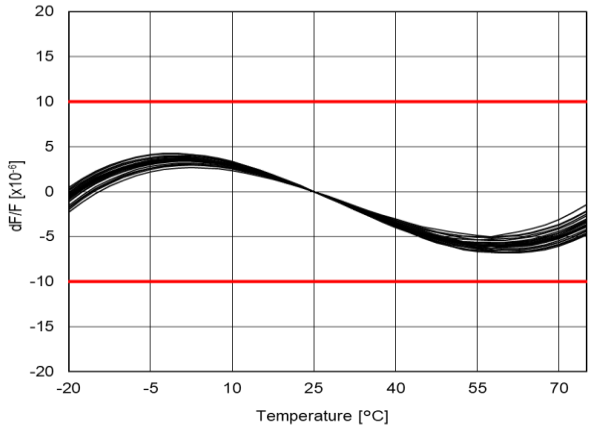
19.2 MHz n = 30



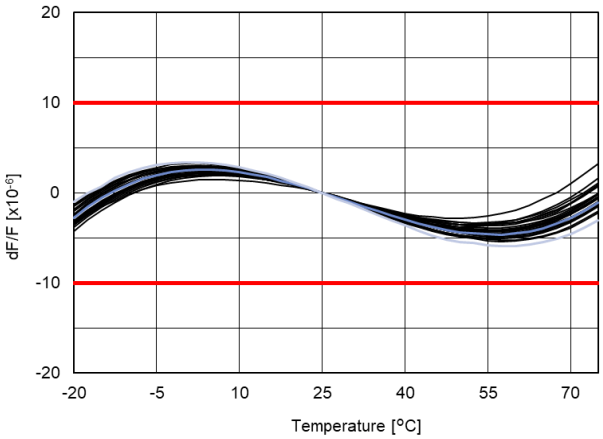
20 MHz n = 30



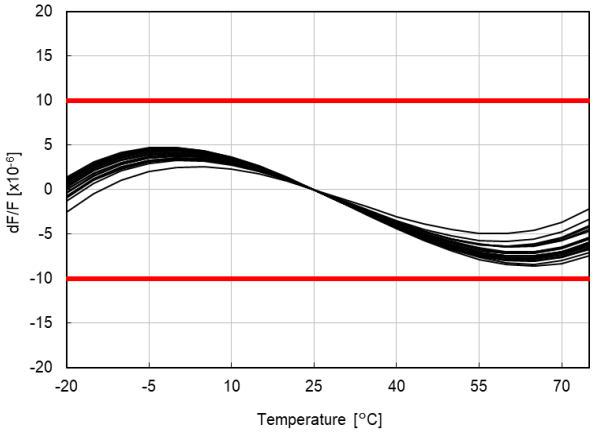
24 MHz n = 30



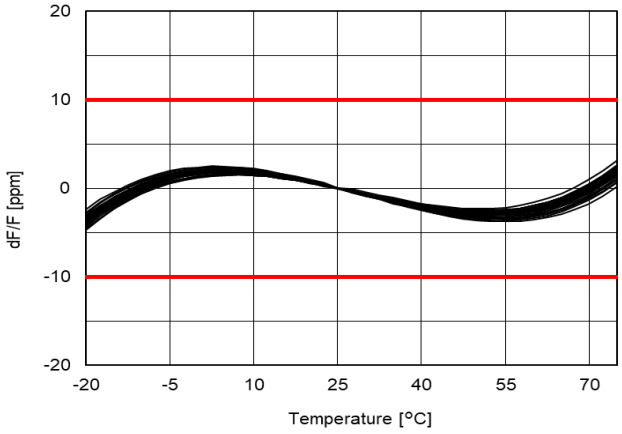
24.576 MHz n = 30



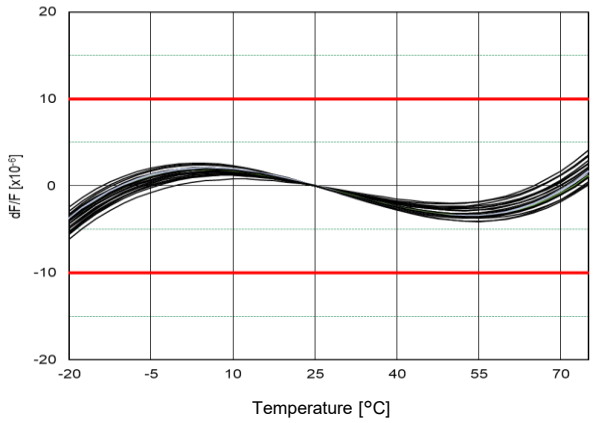
25 MHz n = 30



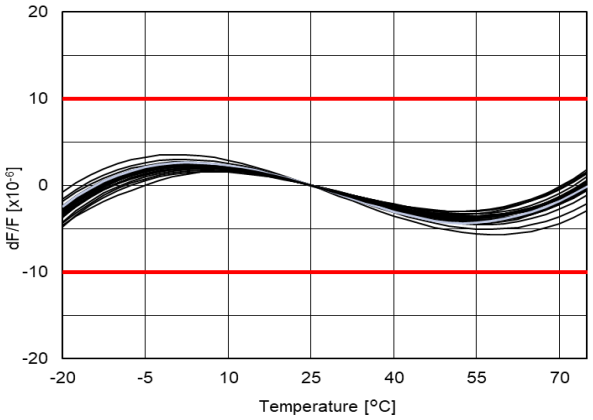
26 MHz n = 30



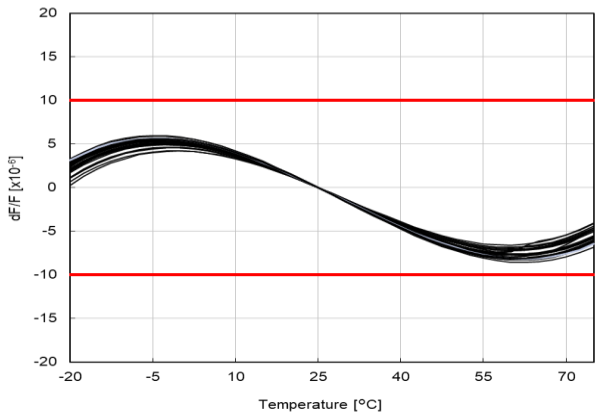
27.12 MHz n = 30



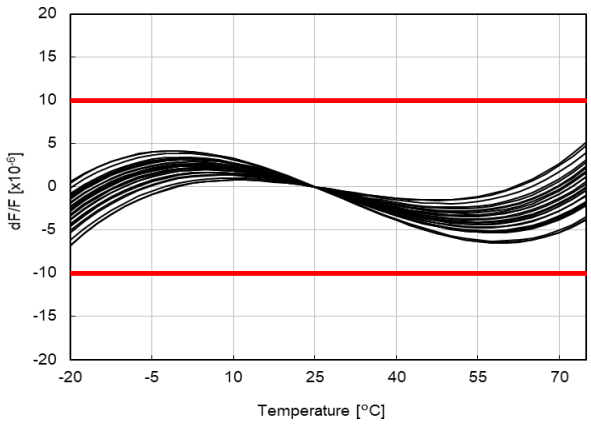
32 MHz n = 30



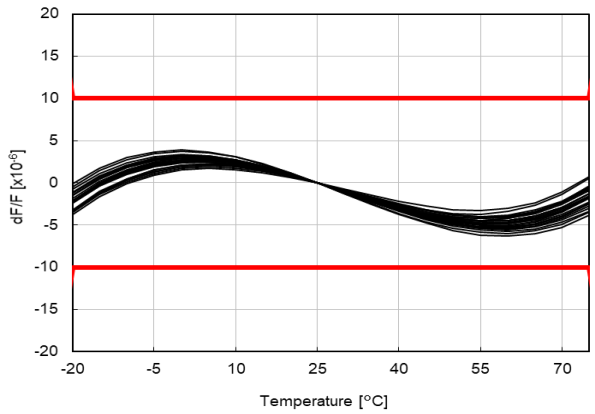
37.4 MHz n = 30



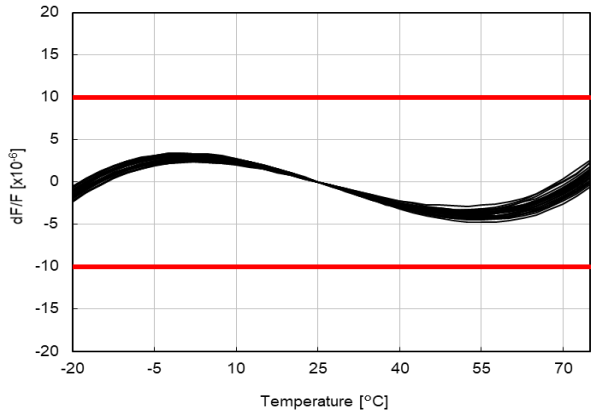
38.4 MHz n = 30



40 MHz n = 30



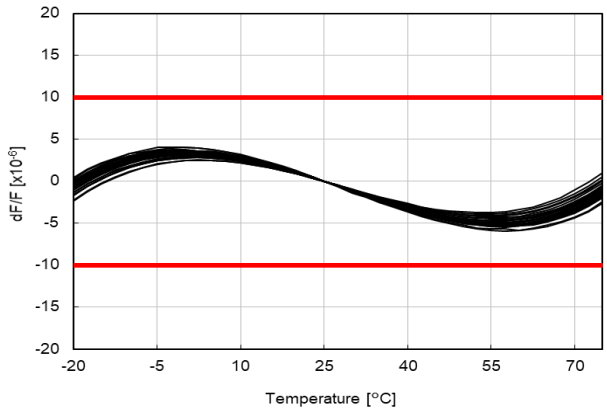
48 MHz n = 30



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52 MHz n = 30



[6] Marking Description

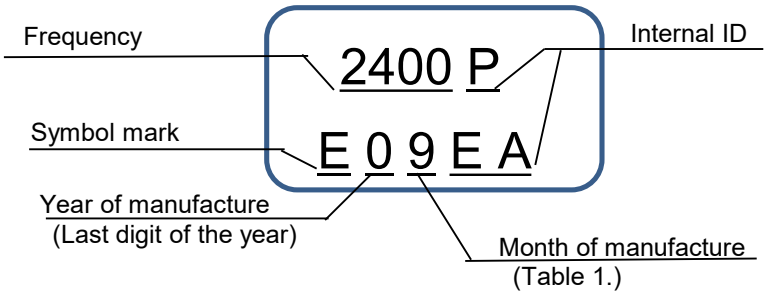
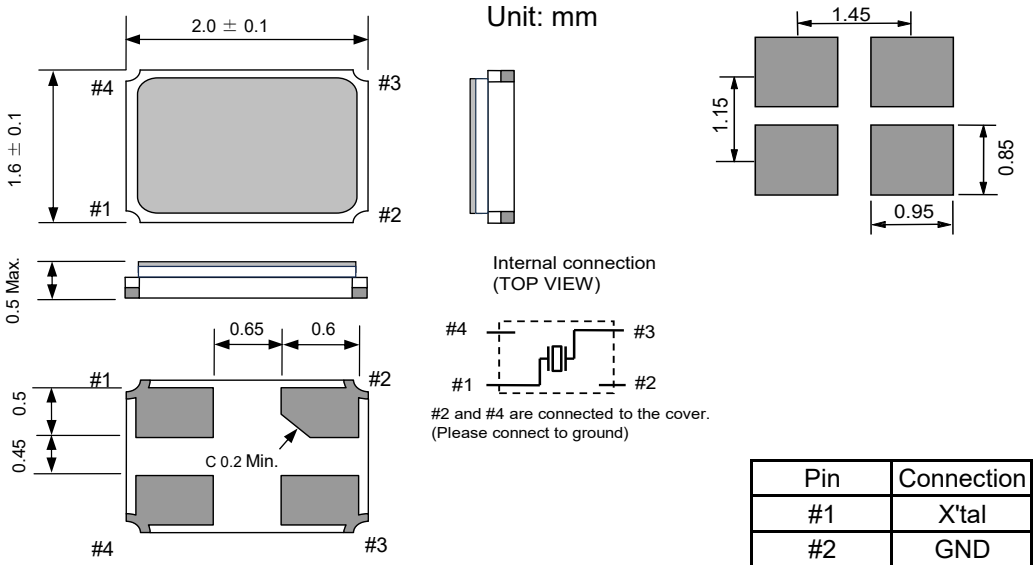


Table 1. Month of manufacture

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	X	Y	Z

[7] Outline Drawing and Recommended Footprint



Pin	Connection
#1	X'tal
#2	GND
#3	X'tal
#4	GND

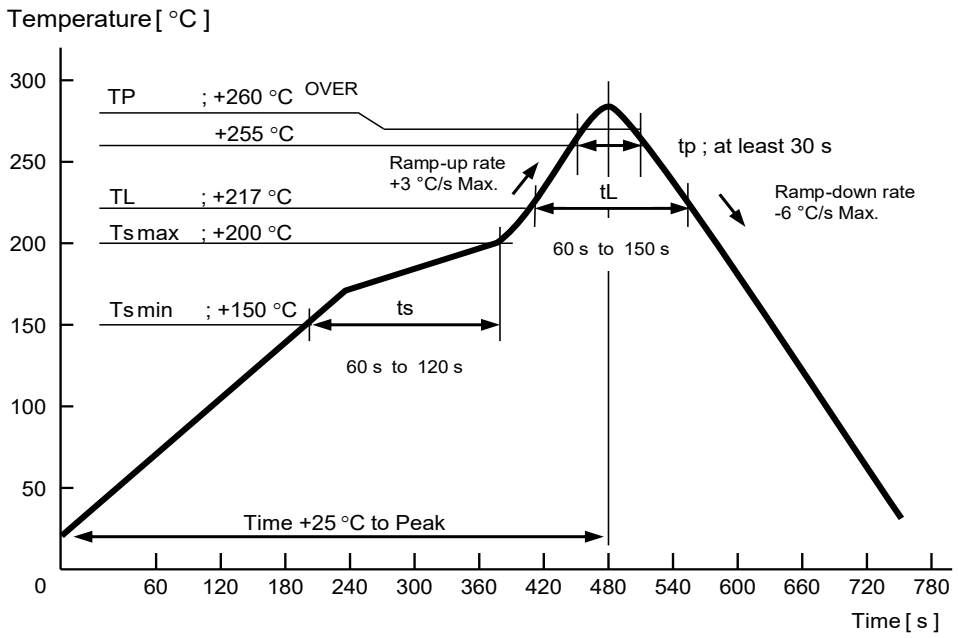
Reference weight Typ.: 7 mg

Terminal coating: Au plating

[8] Moisture Sensitivity Level

Parameter	Specification	Conditions
MSL	LEVEL1	JEDEC J-STD-020D.01

[9] Reflow Profile (JEDEC J-STD-020D.01)



[10] Packing Information

(1) Packing Quantity

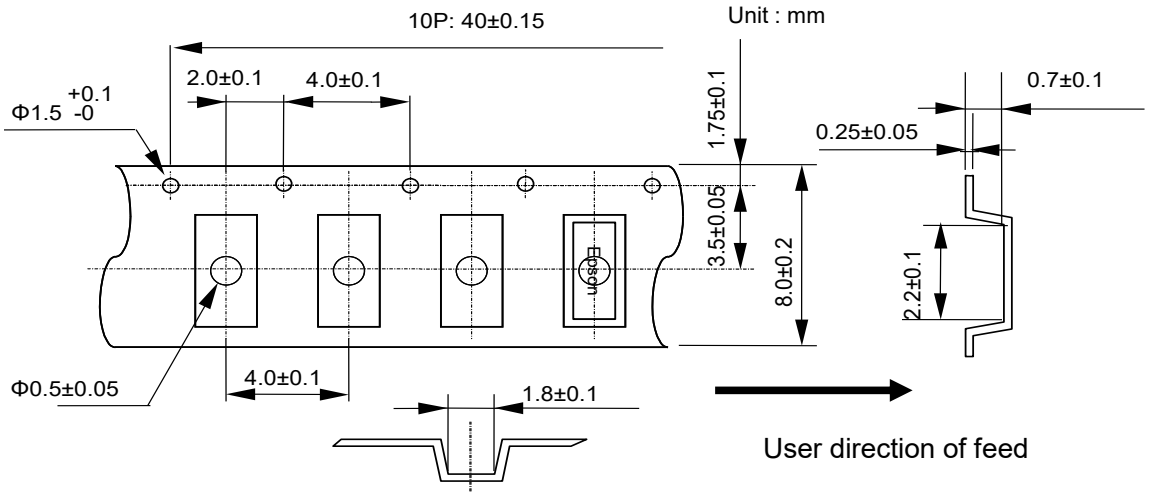
The last two digits of the Product Number (Q22FA1280xxxx**xx**) are a code that defines the packing quantity.
The standard is "18" for a 5 000 pcs / Reel.

(2) Taping Specification

Subject to EAI-481, IEC 60286 and JIS C0806

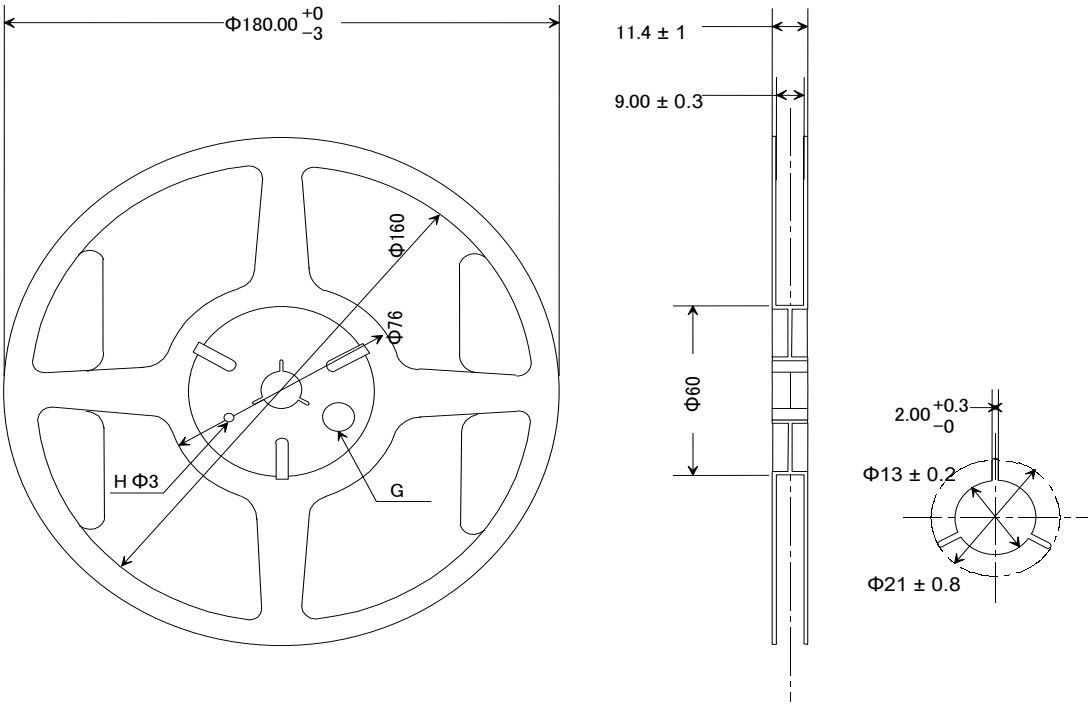
(2-1) Tape Dimensions

Carrier Tape Material : PS (Polystyrene)
Top Tape Material : PET (Polyethylene Terephthalate) + PE (Polyethylene)



(2-2) Reel Dimensions

Center Material : PS (Polystyrene)
Reel Material : PS (Polystyrene)

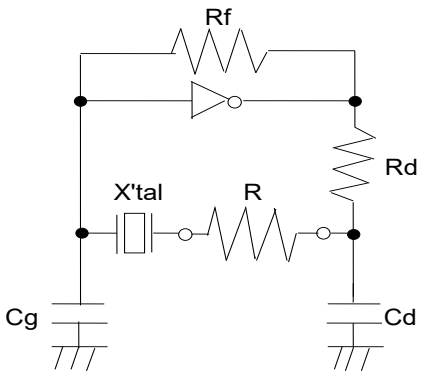


[11] Handling Precautions

Prior to using this product, please carefully read the section entitled “Precautions” on our Web site (https://www.epsondevice.com/crystal/en/support/precaution/) for instructions on how to handle and use the product properly to ensure optimal performance of the product in your equipment.
Before using the product under any conditions other than those specified therein, please consult with us to verify and confirm that the performance of the product will not be negatively affected by use under such conditions.
In addition to the foregoing precautions, in order to avoid the deteriorating performance of the product, we strongly recommend that you DO NOT use the product under ANY of the following conditions:

1. Max three (3) times re-flow is allowed. Its recommended to manually solder when not enough/no solder detected.(Using soldering iron at +350 °C Max × within 5 seconds)
2. Avoid using the products if it received any excessive shocks and vibrations
   Crystal products may be damaged under some conditions during mounting if exposed to excess shock.
   Please set the mounting conditions to a slow mounting speed on the PCB to minimize shock as much as possible.
   Please review the conditions after the changed are made.
3. Keep the electrode wiring as short as possible to ensure normal oscillation.
4. Store the crystal products at normal temperature (+15 ° C to +35 ° C) and humidity (25 %RH to 85 %RH)
   Storing the crystal products under higher temperature or high humidity over one year may affect frequency stability or solderability.
   Contact Epson before use if the product has been stored outside the conditions mentioned above.
5. Ultrasonic equipment used for cleaning or bonding may deteriorate the characteristics of the product.
   Be sure to check in advance.
6. In high humidity environment, dew condensation on the PCB board may cause malfunction such frequency shift or no oscillation.
7. Applying excessive drive level to the crystal units may cause deterioration of characteristics or damage.
   Design and test the circuit so that the proper drive level is maintained.
8. The characteristic such as frequency, etc. may differ from your measurement depending on the measurement method or conditions.
   Contact Epson for any questions.
9. In order to avoid malfunction by other signal lines, design pattern other signal lines away from the product.
   and in case of multi-layered PCB board, do not lay out other signal lines under.
   If shielding with GND is required, shield the surface farthest from the oscillation circuits.
10. Ensure adequate negative resistance is allocated in the oscillation circuit,
    otherwise oscillation startup time may increase or no oscillation may occur.
    In order to avoid this, provide enough negative resistance that is 5 to 10 time the motional resistance(R1)
11. Aging specifications are estimated from environmental reliability tests and expected frequency variation over time.
    They do not provide a guarantee of aging over the product lifecycle.
12. Should any customer use the product in any manner contrary to the precautions and/or advice herein,
    such use shall be done at the customer’s own risk.

How to check the negative resistance.



1) Insert a pure resistance R in series with the X'tal.

2) Adjust R and find the maximum R value that starts oscillation.

3) Check the value of R in the oscillation state of 2).
   Negative resistance of the circuit |-R| =
   R + Series resistance value R1 of the X'tal

4) Negative resistance |-R| guideline:
   |-R| > R1 Max. x 5 to 10

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At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

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RoHS Compliant	**●Complies with EU RoHS directive.** *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive (Contains Pb in sealing glass, high melting temperature type solder or other)

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